

Product Summary

Part Number	$V_{GS(off)}$ (V)	$V_{(BR)GSS}$ Min (V)	g_{fs} Min (mS)	I_{DSS} Max (mA)
2N4338	-0.3 to -1	-50	0.6	0.6
2N4339	-0.6 to -1.8	-50	0.8	1.5
2N4340	-1 to -3	-50	1.3	3.6
2N4341	-2 to -6	-50	2	9

For applications information see AN102, page 6, AN106, page 28.

Features

- Low Cutoff Voltage: 2N4338 <1 V
- High Input Impedance
- Very Low Noise
- High Gain: $A_V = 80$ @ 20 μ A

Benefits

- Full Performance from Low-Voltage Power Supply: Down to 1 V
- Low Signal Loss/System Error
- High System Sensitivity
- High-Quality Low-Level Signal Amplification

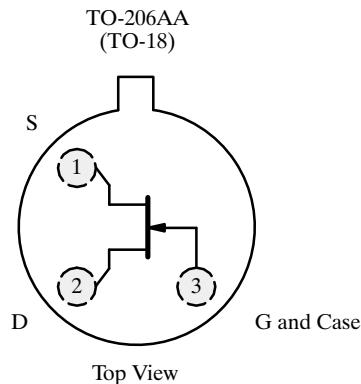
Applications

- High-Gain, Low-Noise Amplifiers
- Low-Current, Low-Voltage Battery-Powered Amplifiers
- Infrared Detector Amplifiers
- Ultrahigh Input Impedance Pre-Amplifiers

Description

The 2N4338/4339/4340/4341 n-channel JFETs are designed for sensitive amplifier stages at low- to mid-frequencies. Low cut-off voltages accommodate low-level power supplies and low leakage for improved system accuracy.

The TO-206AA (TO-18) package is hermetically sealed and suitable for military processing (see Military Information). For similar products in TO-226AA (TO-92) and TO-236 (SOT-23) packages, see the J/SST201 series data sheet.



Absolute Maximum Ratings

Gate-Source/Gate-Drain Voltage	-50 V
Forward Gate Current	50 mA
Storage Temperature	-65 to 200°C
Operating Junction Temperature	-55 to 175°C

Lead Temperature (1/16" from case for 10 sec.)	300°C
Power Dissipation ^a	300 mW

Notes

a. Derate 2 mW/°C above 25°C

Specifications^a for 2N4338 and 2N4339

Parameter	Symbol	Test Conditions	Typ ^b	Limits				Unit	
				2N4338		2N4339			
				Min	Max	Min	Max		
Static									
Gate-Source Breakdown Voltage	V _{(BR)GSS}	I _G = -1 μA, V _{DS} = 0 V	-57	-50		-50		V	
Gate-Source Cutoff Voltage	V _{GS(off)}	V _{DS} = 15 V, I _D = 0.1 μA		-0.3	-1	-0.6	-1.8		
Saturation Drain Current ^c	I _{DSS}	V _{DS} = 15 V, V _{GS} = 0 V		0.2	0.6	0.5	1.5	mA	
Gate Reverse Current	I _{GSS}	V _{GS} = -30 V, V _{DS} = 0 V T _A = 150°C	-2 -4		-100		-100	pA nA	
Gate Operating Current ^c	I _G	V _{DG} = 15 V, I _D = 0.1 mA	-2					pA	
Drain Cutoff Current	I _{D(off)}	V _{DS} = 15 V, V _{GS} = -5 V	2		50		50		
Gate-Source Forward Voltage ^d	V _{GS(F)}	I _G = 1 mA, V _{DS} = 0 V	0.7					V	
Dynamic									
Common-Source Forward Transconductance	g _{fs}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 kHz		0.6	1.8	0.8	2.4	mS	
Common-Source Output Conductance	g _{os}				5		1.5	μS	
Drain-Source On-Resistance ^c	r _{ds(on)}	V _{DS} = 0 V, V _{GS} = 0 V, f = 1 kHz			2500		1700	Ω	
Common-Source Input Capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	5		7		7	pF	
Common-Source Reverse Transfer Capacitance	C _{rss}		1.5		3		3		
Equivalent Input Noise Voltage ^d	ē _n	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 kHz	6					nV/√Hz	
Noise Figure	NF	V _{DS} = 15 V, V _{GS} = 0 V f = 1 kHz, R _G = 1 MΩ			1		1	dB	

Specifications^a for 2N4340 and 2N4341

Parameter	Symbol	Test Conditions	Typ ^b	Limits				Unit	
				2N4340		2N4341			
				Min	Max	Min	Max		
Static									
Gate-Source Breakdown Voltage	V _{(BR)GSS}	I _G = -1 μA, V _{DS} = 0 V	-57	-50		-50		V	
Gate-Source Cutoff Voltage	V _{GS(off)}	V _{DS} = 15 V, I _D = 0.1 μA		-1	-3	-2	-6		
Saturation Drain Current ^c	I _{DSS}	V _{DS} = 15 V, V _{GS} = 0 V		1.2	3.6	3	9	mA	
Gate Reverse Current	I _{GSS}	V _{GS} = -30 V, V _{DS} = 0 V T _A = 150°C	-2 -4		-100		-100	pA	
Gate Operating Current ^c	I _G	V _{DG} = 15 V, I _D = 0.1 mA	-2					pA	
Drain Cutoff Current	I _{D(off)}	V _{DS} = 15 V V _{GS} = -5 V V _{GS} = -10 V	2		50				
Gate-Source Forward Voltage	V _{GS(F)}		3				70		
		I _G = 1 mA, V _{DS} = 0 V	0.7					V	

Specifications^a for 2N4340 and 2N4341

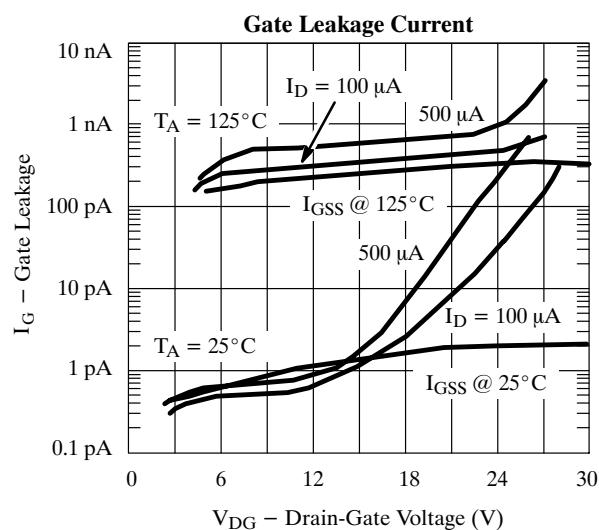
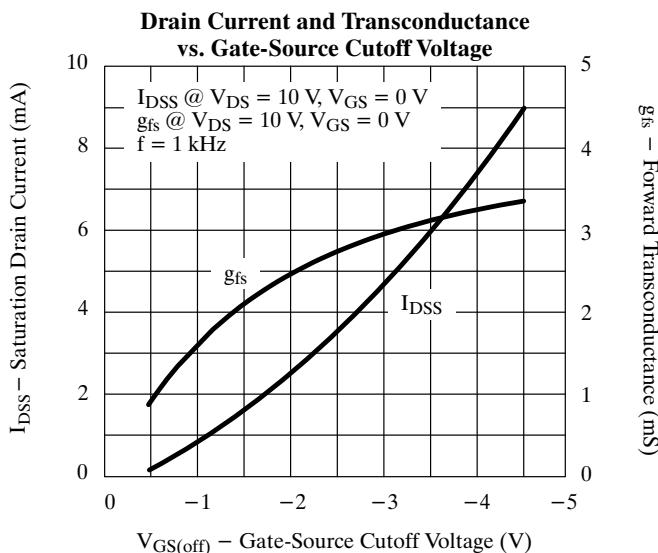
Parameter	Symbol	Test Conditions	Typ ^b	Limits				Unit
				2N4340	2N4341	Min	Max	
Dynamic								
Common-Source Forward Transconductance	g_{fs}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ kHz}$	1.3	1.3	3	2	4	mS
Common-Source Output Conductance	g_{os}			30		60	μS	
Drain-Source On-Resistance ^c	$r_{ds(on)}$	$V_{DS} = 0 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ kHz}$		1500		800		Ω
Common-Source Input Capacitance	C_{iss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	5		7		7	pF
Common-Source Reverse Transfer Capacitance	C_{rss}		1.5		3		3	
Equivalent Input Noise Voltage ^d	\bar{e}_n	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ kHz}$	6					$\frac{\text{nV}}{\sqrt{\text{Hz}}}$
Noise Figure	NF	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$ $f = 1 \text{ kHz}, R_G = 1 \text{ M}\Omega$			1		1	dB

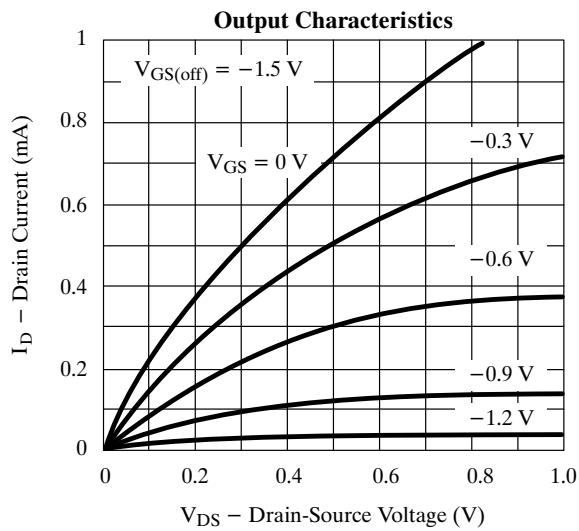
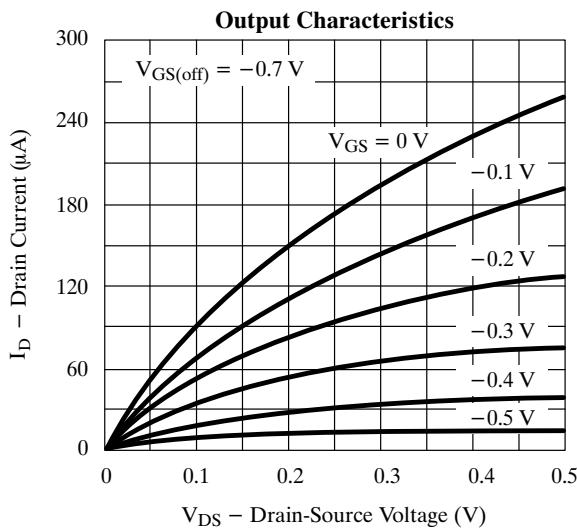
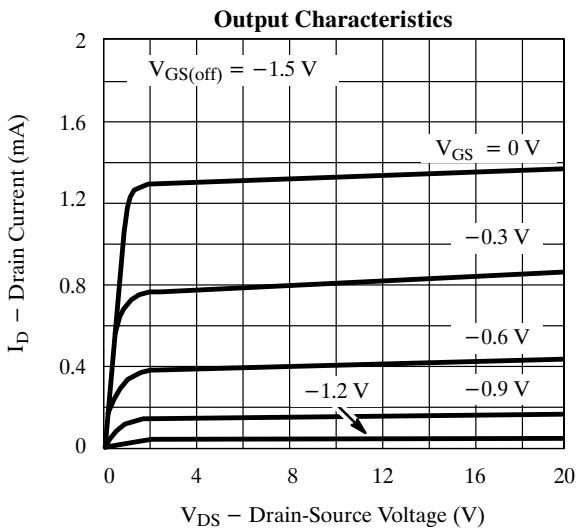
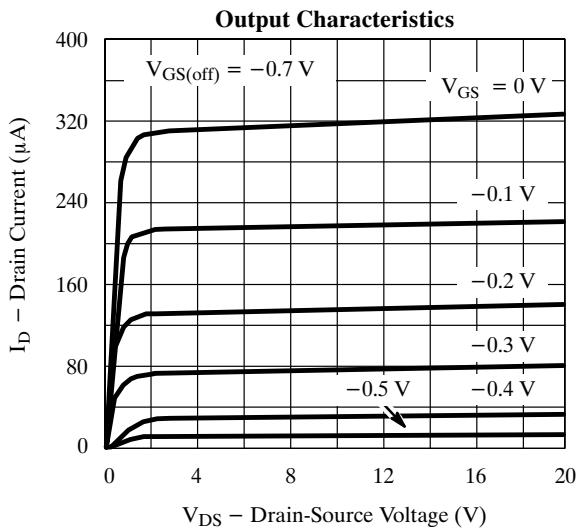
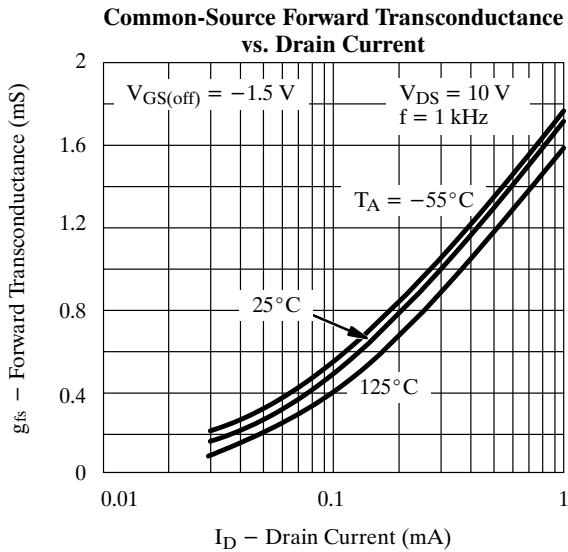
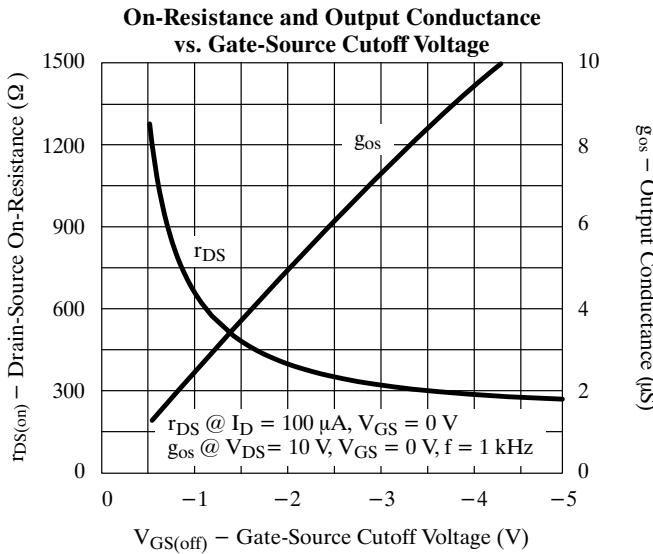
Notes

- a. $T_A = 25^\circ\text{C}$ unless otherwise noted.
- b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- c. Pulse test: $PW \leq 300 \mu\text{s}$, duty cycle $\leq 3\%$.
- d. This parameter not registered with JEDEC.

NPA

Typical Characteristics



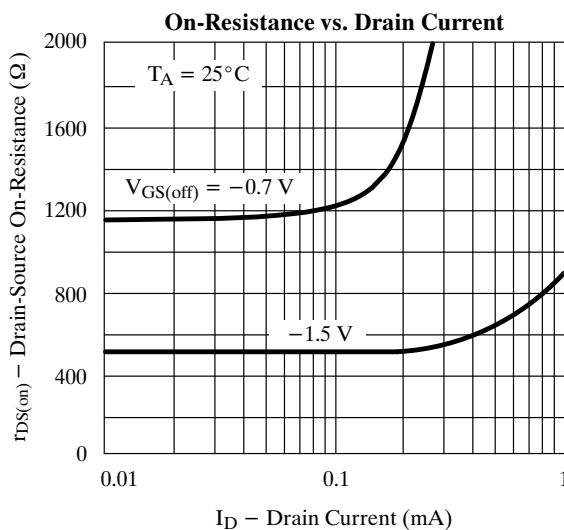
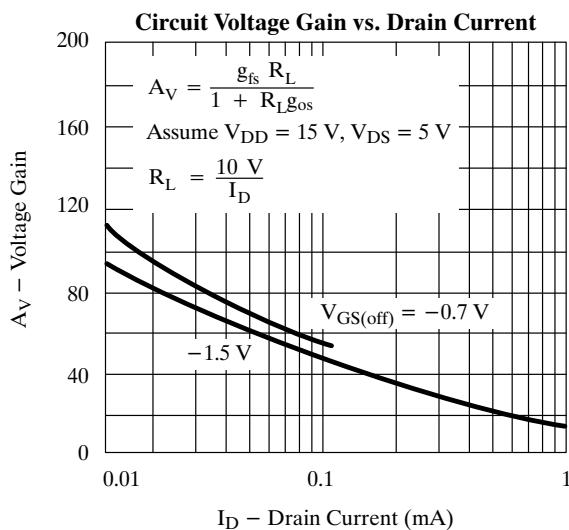
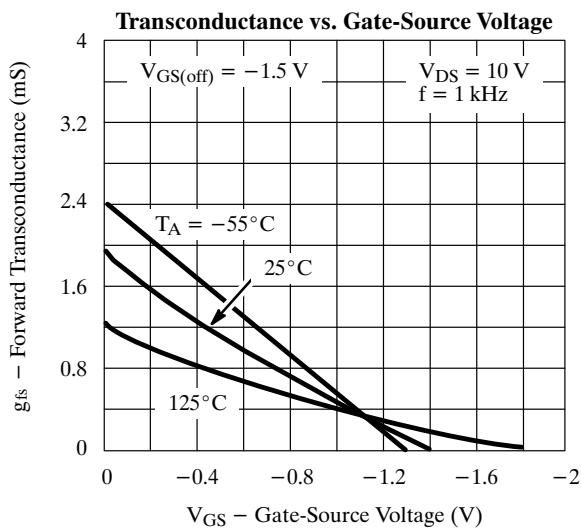
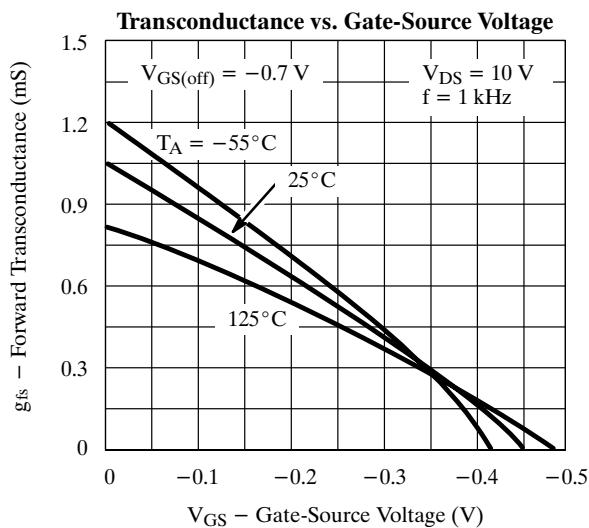
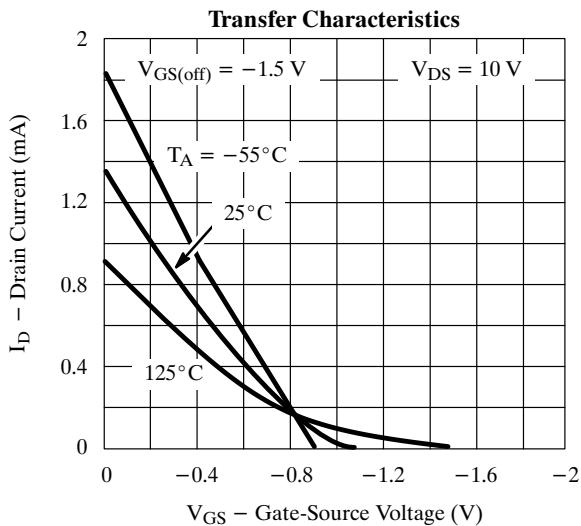
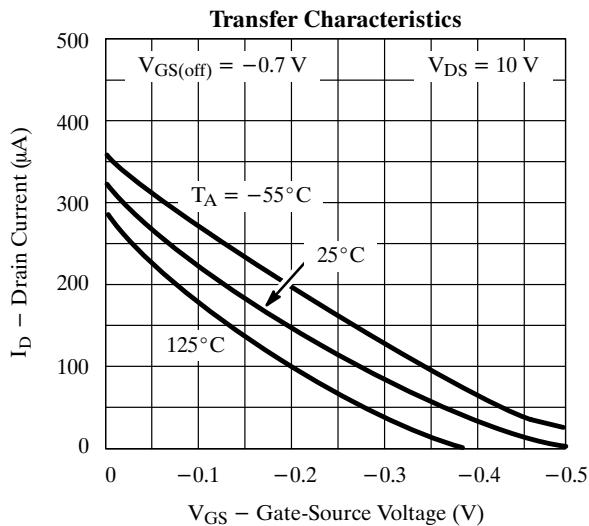
2N4338/4339/4340/4341**Typical Characteristics (Cont'd)**

TEMIC

Siliconix

2N4338/4339/4340/4341

Typical Characteristics (Cont'd)



Typical Characteristics (Cont'd)

